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December 1995, Rev. E

FN7033

## 730MHz Closed Loop Buffer

# élantec.

The EL2072 is a wide bandwidth, fast settling monolithic buffer built using an advanced complementary bipolar

process. This buffer is closed loop to achieve lower output impedance and higher gain accuracy. Designed for closedloop unity gain, the EL2072 has a 730MHz -3dB bandwidth and 5ns settling to 0.2% while consuming only 15mA of supply current.

The EL2072 is an obvious high-performance solution for video distribution and line-driving applications. With low 15mA supply current and a 70mA output drive, performance in these areas is assured.

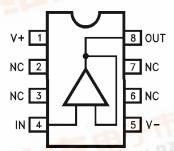
The EL2072's settling to 0.2% in 5ns, low distortion, and ability to drive capacitive loads make it an ideal flash A/D driver. The wide 730MHz bandwidth and extremely linear phase allow unmatched signal fidelity.

The EL2072 can be used inside an amplifier loop or PLL as its wide bandwidth and fast rise time have minimal effect on loop dynamics.

Elantec products and facilities comply with MIL-I-45028A, and other applicable quality specifications. For information on Elantec's processing, see Elantec document QRA-1: Elantec's Processing, Monolithic Integrated Circuits.

### **Pinout**

EL2072 (8-PIN PDIP SO) TOP VIEW



Manufactured under U.S. Patent No. 4,893,091

#### **Features**

- 730MHz -3dB bandwidth (0.5V<sub>PP</sub>)
- 5ns settling to 0.2%
- V<sub>S</sub> = ±5V @ 15mA
- Low distortion: HD2, HD3 of -65dBc at 20MHz
- · Overload/short-circuit protected
- · Closed-loop, unity gain
- Low cost
- Direct replacement for CLC110

### **Applications**

- Video buffer
- Video distribution
- HDTV buffer
- High-speed A/D buffer
- Photodiode, CCD preamps
- IF processors
- · High-speed communications

High-speed communications								
Ordering Information								
PART NUMBER	TEMP. RANGE	PACKAGE	PKG. NO.					
EL2072CN	-40°C to +85°C	8-Pin PDIP	MDP0031					
EL2072CS	-40°C to +85°C	8-Pin SO	MDP0027					



# **Absolute Maximum Ratings** $(T_A = 25$ °C)

Supply Voltage (V <sub>S</sub> )	±7V	Junction Temperature	175°C
Output Current		Storage Temperature	60°C to +150°C
Output is short-circuit protected to ground, howe	ver, maximum reliability is	Thermal Resistance	θ <sub>JA</sub> = 95°C/W PDIF
obtained if I <sub>OUT</sub> does not exceed 70mA.			θ <sub>JA</sub> = 175°C/W SC
Input Voltage	±V <sub>S</sub>	Note: See EL2071/EL2171 for Therr	mal Impedance curves.
Operating Temperature	-40°C to ±85°C		

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

IMPORTANT NOTE: All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$ 

# **DC Electrical Specifications** $V_S = \pm 5V$ , $R_L = 100\Omega$ , $R_S = 50\Omega$ unless otherwise specified

PARAMETER	DESCRIPTION	TEST CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
V <sub>OS</sub>	Output Offset Voltage		25°C		2.0	8.0	mV
			T <sub>MIN</sub>			16.0	mV
			T <sub>MAX</sub>			13.0	mV
TCV <sub>OS</sub>	Average Offset Voltage Drift		25°C - T <sub>MAX</sub>		20.0	50.0	μV/°C
			25°C - T <sub>MIN</sub>		20.0	100.0	
I <sub>B</sub>	Input Bias Current		25°C, T <sub>MAX</sub>		10.0	50.0	μA
			T <sub>MIN</sub>			100.0	μΑ
TCIB	Average Input Bias Current Drift		25°C - T <sub>MAX</sub>		200.0	300.0	nA/°C
			25°C - T <sub>MIN</sub>		200.0	700.0	
A <sub>V</sub>	Small Signal Gain	$R_L = 100\Omega$	25°C	0.96	0.98		V/V
			T <sub>MIN</sub> , T <sub>MAX</sub>	0.95			V/V
ILIN	Integral End Point linearity	±2V F.S.	25°C		0.2	0.4	%F.S.
			T <sub>MIN</sub>			0.8	%F.S.
			T <sub>MAX</sub>			0.3	%F.S.
PSRR	Power Supply Rejection Ratio		All	45.0	65.0		dB
IS	Supply Current—Quiescent	No Load	All		15.0	20.0	mA
R <sub>IN</sub>	Input Resistance		25°C	100.0	160.0		kΩ
			T <sub>MIN</sub>	50.0			kΩ
			T <sub>MAX</sub>	200.0			kΩ
C <sub>IN</sub>	Input Capacitance		25°C		1.6	2.2	pF
			T <sub>MIN</sub> , T <sub>MAX</sub>			2.5	pF
R <sub>OUT</sub>	Output Impedance (DC)		25°C		2.0	3.0	Ω
			T <sub>MIN</sub> , T <sub>MAX</sub>			3.5	Ω
lout	Output Current		25°C, T <sub>MAX</sub>	50.0	70.0		mA
			T <sub>MIN</sub>	45.0			mA
V <sub>OUT</sub>	Output Voltage Swing	$R_L = 100\Omega$	25°C, T <sub>MAX</sub>	±3.2	±4.0		V
			T <sub>MIN</sub>	±3.0			V

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**AC Electrical Specifications**  $V_S = \pm 5V$ ,  $R_L = 100\Omega$ ,  $R_S = 50\Omega$  unless otherwise specified

PARAMETER	DESCRIPTION	TEST CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
FREQUENCY R	ESPONSE				•	•	•
SSBW	-3dB Bandwidth		25°C	400.0	730.0		MHz
	(V <sub>OUT</sub> < 0.5V <sub>PP</sub> )		T <sub>MIN</sub>	400.0			MHz
			T <sub>MAX</sub>	300.0			MHz
LSBW	-3dB Bandwidth		25°C	55.0	90.0		MHz
	$(V_{OUT} = 5.0V_{PP})$		T <sub>MIN</sub> , T <sub>MAX</sub>	50.0			MHz
GAIN FLATNES	SS						
GFPL	Peaking V <sub>OUT</sub> < 0.5V <sub>PP</sub>	< 200MHz	25°C		0.0	0.5	dB
			T <sub>MAX</sub>			0.6	dB
			T <sub>MIN</sub>			0.8	dB
GFR	Rolloff V <sub>OUT</sub> < 0.5V <sub>PP</sub>	< 200MHz	25°C		0.0	0.8	dB
			T <sub>MIN</sub>			1.0	dB
			T <sub>MAX</sub>			1.2	dB
GDL	Group Delay	< 200MHz	25°C, T <sub>MIN</sub>		0.75	1.0	ns
			T <sub>MAX</sub>			1.2	ns
LPD	Linear Phase Deviation V <sub>OUT</sub> < 0.5V <sub>PP</sub>	< 200MHz	25°C, T <sub>MIN</sub>		0.7	1.5	۰
			T <sub>MAX</sub>			2.0	٥
TIME-DOMAIN	RESPONSE					1	
TR1, TF1	Rise Time, Fall Time Input Signal Rise/Fall = 300ps	0.5V Step	25°C, T <sub>MIN</sub>		0.4	1.0	ns
			T <sub>MAX</sub>			1.4	ns
	Rise Time, Fall Time	5.0V Step	25°C		4.5	7.5	ns
	Input Signal Rise/Fall ð 1ns		T <sub>MIN</sub> , T <sub>MAX</sub>			8.5	ns
	Settling Time to 0.2% Input Signal Rise/Fall ð 1ns	2.0V Step	All		5.0	10.0	ns
os	Overshoot Input Signal Rise/Fall = 300ps	0.5V Step	25°C		0.0	10.0	%
			T <sub>MIN</sub> , T <sub>MAX</sub>			15.0	%
SR	Slew Rate		25°C	500.0	800.0		V/µs
			T <sub>MIN</sub> , T <sub>MAX</sub>	450.0			V/µs
DISTORTION	1						
HD2	2nd Harmonic Distortion at 20MHz	2Vpp	25°C		-55.0	-50.0	dBc
			T <sub>MIN</sub>			-48.0	dBc
			T <sub>MAX</sub>			-55.0	dBc
HD2A	2nd Harmonic Distortion at 50MHz	2Vрр	25°C, T <sub>MAX</sub>		-50.0	-45.0	dBc
			T <sub>MIN</sub>			-40.0	dBc
HD3	3rd Harmonic Distortion at 20MHz	2V <sub>PP</sub>	25°C		-65.0	-55.0	dBc
			T <sub>MIN</sub> , T <sub>MAX</sub>			-55.0	dBc
HD3A	3rd Harmonic Distortion at 50MHz	2V <sub>PP</sub>	25°C, T <sub>MIN</sub>		-60.0	-50.0	dBc
			T <sub>MAX</sub>			-45.0	dBc

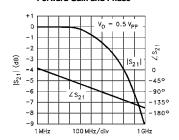
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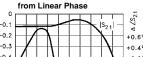
# **AC Electrical Specifications** $V_S = \pm 5V$ , $R_L = 100\Omega$ , $R_S = 50\Omega$ unless otherwise specified **(Continued)**

PARAMETER	DESCRIPTION	TEST CONDITIONS	TEMP	MIN	TYP	MAX	UNITS	
EQUIVALENT INPUT NOISE								
NF Noise Floor > 100kHz			25°C, T <sub>MIN</sub>		-158.0	-155.0	dBm (1Hz)	
	> 100kHz		T <sub>MAX</sub>			-154.0	dBm (1Hz)	
	Integrated Noise 100kHz to 200MHz		25°C, T <sub>MIN</sub>		40.0	57.0	μV	
			T <sub>MAX</sub>			63.0	μV	

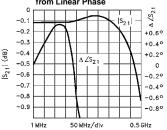
### Typical Performance Curves

### Forward Gain and Phase

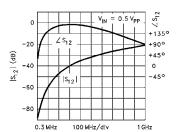




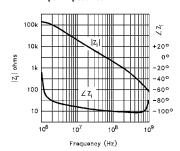
Gain Flatness & Deviation



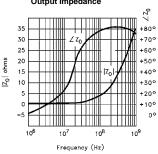
#### Reverse Gain and phase



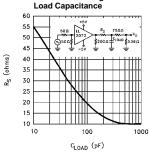
Input Impedance



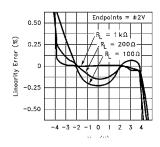
Output Impedance



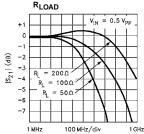
Recommended R<sub>S</sub> vs



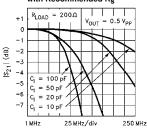
Integral Linearity Error



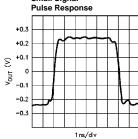
Frequency Response vs

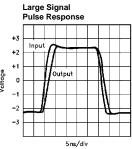


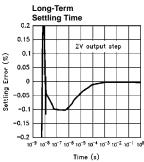
|S<sub>21</sub>| vs C<sub>LOAD</sub> with Recommended R<sub>s</sub>



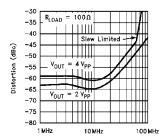
Small Signal Pulse Response



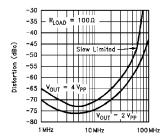




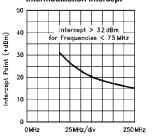
2nd Harmonic Distortion



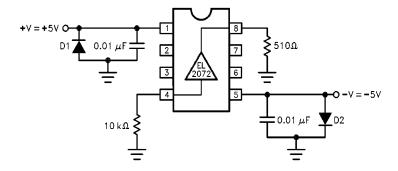
3rd Harmonic Distortion



2-Tone, 3rd Order Intermodulation Intercept



### **Burn-In Circuit**



### **Printed Circuit Layout**

As with any high-frequency device, good PCB layout is necessary for optimum performance. This is especially important for the EL2072, which has a typical bandwidth of 730MHz. Ground plane construction is a requirement, as is good power-supply bypassing close to the package. A closely-placed 0.01µF ceramic capacitor between each supply pin and the ground plane is usually sufficient decoupling.

Pins 2, 3, 6, and 7 should be connected to the ground-plane to minimize capacitive feedthrough, and all input and output traces should be laid out as transmission lines and terminated as close to the EL2072 package as possible.

Increasing capacitance on the output of the EL2072 will add phase shift, decreasing phase margin and increasing frequency-response peaking. A small series resistor before the capacitance decouples this effect, and should be used for large capacitance values. Please refer to the graphs for the appropriate resistor value to be used.

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